# First characterization of TI-LGAD technology in a test beam setup

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#### The TI-LGAD technology

Goal: Sensor with small pixels (<= 100 um) and high Fill Factor (> 80%).

TI-LGAD FBK RD50 production:

- Trenches: 1 or 2.
- Contact type: "Ring" or "dot".
- Pixel border: "V1" < "V2" < "V3" < "V4".
- Trench depth: "D1" < "D2" < "D3".





#### Test beam setup

Simplified diagram:



- CERN H6 beamline (120 GeV pions)
- Mimosa telescope
- Chubut 2, 4 channels readout board<sup>1</sup>
- CAEN DT5742 digitizer, 500 MHz @ 5 GS/s
- Cold box for irradiated DUTs, down to -12 °C
- Tracks reconstruction using Corryvreckan<sup>2</sup>
- <sup>1</sup> <u>https://github.com/SengerM/Chubut\_2</u> **4** <sup>2</sup> <u>https://project-corryvreckan.web.cern.ch/project-corryvreckan/</u>

#### Test beam setup

#### Some photos:





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#### Waveforms analysis

We record the waveforms, then process them offline\*. Example:



#### Tested devices

- All from FBK RD50 TI-LGAD production
- Same physical layout and connection  $\rightarrow$
- 8 DUTs, details in table below L

device_name	wafer	trench process	trench depth	trenches	pixel border	contact type	Fluence (neq/cm²)
TI116	16	P2	D3	1	V3	dot	0.0E+0
TI122	16	P2	D3	1	V3	ring	0.0E+0
TI123	16	P2	D3	1	V3	ring	0.0E+0
TI143	16	P2	D3	1	V2	ring	0.0E+0
TI145	16	P2	D3	1	V2	ring	1.0E+15
TI146	16	P2	D3	1	V2	ring	1.0E+15
TI229	7	P2	D2	1	V3	ring	1.0E+15
TI230	7	P2	D2	1	V3	ring	1.0E+15



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\* Devices were irradiated with reactor neutrons at JSI, Ljubljana.

\*\* "device\_name" can be ignored, it is shown here for curious readers who may want to see details from the examples.

## Results

#### Waveforms distribution and events selection



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#### Waveforms distribution and events selection

- Hits have large amplitude and well defined time.
- Empty waveforms have small amplitude (noise) and random time.



#### Waveforms distribution and events selection

A threshold in amplitude defines what we consider a hit in a pixel:



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#### Tracks and hits on DUTs

• Each dot is a track

250 µm

GND CH3 CH4

GND GND GND

GND

- Colored according to which channel was hit
- Tracks reconstruction using Corryvreckan<sup>1</sup>

CH1 CH2

\* This example is for one DUT, they all look similar. <sup>1</sup> <u>Corryvreckan - CERN</u>



#### Charge sharing in TI-LGADs

\* This example is for two DUTs, they all look similar.

We look at the cluster size, i.e. number of active pixels per hit.



#### Charge sharing in TI-LGADs

\* This example is for two DUTs, they all look similar.

Only ~1 % of events share charge, low value consistent with expectation  $\mathbf{V}$ 

Example for two DUTs (similar for all of them):



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What's the efficiency profile along two pixels?



Select tracks within these strips and project along x and y



200µ

• W16 D3 1T V3 ring

100

98

96

- 0 n<sub>eq</sub> cm<sup>-2</sup>
- 230 V
- Room T

Efficiency (%)



• W16 D3 1T V3 dot

100

98

96

94

92

- 0 n<sub>eq</sub> cm<sup>-2</sup>
- 230 V
- Room T

Efficiency (%)



## Irradiated TI-LGADs

#### Waveforms distribution for irradiated TI-LGAD



- W7 D2 1T V3 ring: Low noise, amplitude threshold at -5 mV  $\swarrow$  (same as non irrad)
- W16 D3 1T V2 ring\*: Noisier  $\rightarrow$  higher amplitude threshold & less gain  $\rightarrow$  lower efficiency 🙁

\* During the test beam a single voltage point was taken, it is possible that if e.g. 490 V instead of 500 V would have been applied, the noise would be greatly reduced.

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W7 D2 1T V3 ring 

100

96

94

1n<sub>eq</sub> cm<sup>-2</sup>

Efficiency (%)

- 525 V
- -12 °C



Efficiency measured in an area of the same size as a pixel. To avoid edge effects, take it close to the center:



- Global efficiency that a large area sensor would have
- Thanks to DUT symmetry, it is translation invariant
- Higher statistics



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\* Senger, M.; Macchiolo, A.; Kilminster, B.; Paternoster, G.; Centis Vignali, M.; Borghi, G. A Comprehensive Characterization of the TI-LGAD Technology. Sensors 2023, 23, 6225. <u>https://doi.org/10.3390/s23136225</u>



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#### Inter-pixel distance (IPD)





\* Unfortunately only one voltage point was taken for V2, it may happen that reducing the voltage a bit fixes this issue and efficiency goes up again



#### Conclusions

- TI-LGAD samples were characterized in a test beam setup.
- Before irradiation, 99.2±0.2 % efficiency measured.
- After 1e15 n<sub>eq</sub> cm<sup>2</sup> with reactor neutrons, 97.4±0.6 % efficiency measured.
- Charge sharing between neighboring pixels very small.

#### Future work

- FBK AIDAinnova TI-LGAD production: Addition of carbon co-implantation for enhanced radiation hardness.
  - Laboratory testing.
  - Test beam testing.

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#### TCT characterization

Almost all design patterns from the FBK RD50 TI-LGAD production were ranked according to their inter-pixel distance as measured with laser TCT, more details in <u>https://doi.org/10.3390/s23136225</u>.



#### Time resolution

Measured in laboratory beta source setup as well as in test beam setup, see <u>https://doi.org/10.3390/s23136225</u> for more details.



